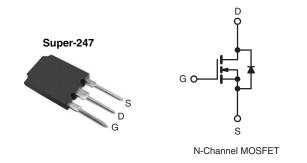


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	500	500				
R _{DS(on)} (Max.) (Ω)	V _{GS} = 10 V	0.13				
Q _g (Max.) (nC)	180	180				
Q _{gs} (nC)	46					
Q _{gd} (nC)	71					
Configuration	Single					



FEATURES

 \bullet Low Gate Charge $\mathbf{Q}_{\mathbf{g}}$ Results in Simple Drive Requirement



Improved Gate, Avalanche and Dynamic dV/dt RoHS

- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Full Bridge Converters
- Power Factor Correction Boost

ORDERING INFORMATION		
Package	Super-247	
Lead (Pb)-free	IRFPS37N50APbF	
Leau (Fb)-liee	SiHFPS37N50A-E3	
SnPb	IRFPS37N50A	
SIFD	SiHFPS37N50A	

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500		
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	- I _D	36	А	
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C		23		
Pulsed Drain Current ^a			I _{DM}	144		
Linear Derating Factor				3.6	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	1260	mJ	
Repetitive Avalanche Current ^a			I _{AR}	36	Α	
Repetitive Avalanche Energy ^a			E _{AR}	44	mJ	
Maximum Power Dissipation	T _C = 25 °C		P_{D}	446	W	
Peak Diode Recovery dV/dt ^c			dV/dt	3.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d	7	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Starting T_J = 25 °C, L = 1.94 mH, R_g = 25 $\Omega,\,I_{AS}$ = 36 A (see fig. 12).
- c. $I_{SD} \le 36$ A, $dI/dt \le 145$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFPS37N50A, SiHFPS37N50A

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	40		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.28		

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 30 V		-	-	± 100	nA
Zana Oata Valta aa Dusin Ouwant	1	V _{DS} = 500 V, V _{GS} = 0 V		-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 \	/, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 22 A ^b	-	-	0.13	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 22 A ^b	20	-	-	S
Dynamic		·					
Input Capacitance	C _{iss}		-	5579	-		
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	810		-
Reverse Transfer Capacitance	C _{rss}			-	36	-	
Output Capacitance	C _{oss}		V _{DS} = 1.0 V , f = 1.0 MHz	-	7905	-	- pF -
		$V_{GS} = 0 V$	V _{DS} = 400 V , f = 1.0 MHz	-	221	-	
Effective Output Capacitance	Coss eff.	1	V _{DS} = 0 V to 400 V	-	400	-	
Total Gate Charge	Q_g			-	-	180	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 36 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 ^b		-	46	nC
Gate-Drain Charge	Q_{gd}	1	goo ng. o ana no	-	-	71	
Turn-On Delay Time	t _{d(on)}			-	23	-	- ns
Rise Time	t _r		= 250 V, I _D = 36 A,	-	98	-	
Turn-Off Delay Time	t _{d(off)}	$R_G = 2$	2.15 Ω , R _D = 7.0 Ω , see fig. 10 ^b	-	52	-	
Fall Time	t _f	366 lig. 10		-	80	-]
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		ı	-	36	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	144	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = 36 A, V _{GS} = 0 V ^b		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 36 A, dl/dt = 100 A/μs ^b		ı	570	860	ns
Body Diode Reverse Recovery Charge	Q_{rr}			-	8.6	13	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.
- c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

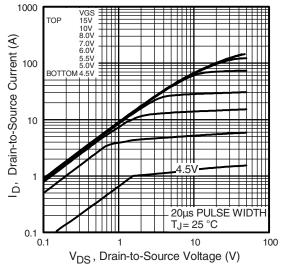


Fig. 1 - Typical Output Characteristics

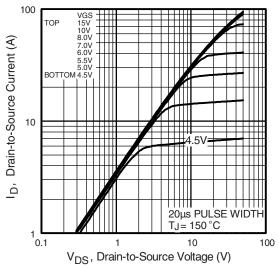


Fig. 2 - Typical Output Characteristics

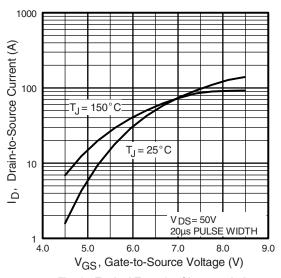


Fig. 3 - Typical Transfer Characteristics

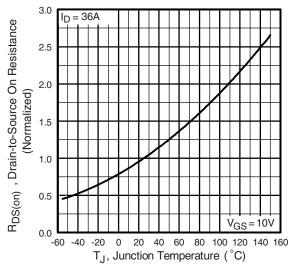


Fig. 4 - Normalized On-Resistance vs. Temperature

IRFPS37N50A, SiHFPS37N50A

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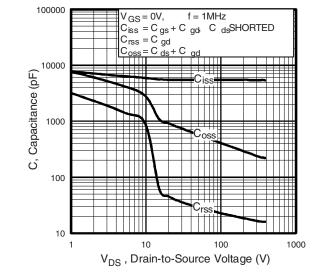


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

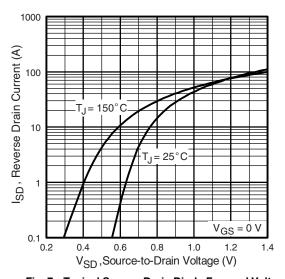


Fig. 7 - Typical Source-Drain Diode Forward Voltage

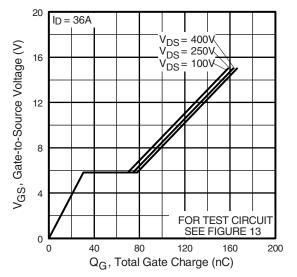


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

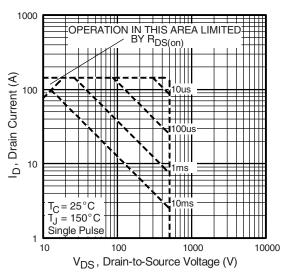


Fig. 8 - Maximum Safe Operating Area





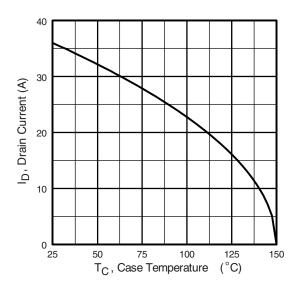


Fig. 9 - Maximum Drain Current vs. Case Temperature

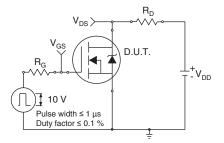


Fig. 10a - Switching Time Test Circuit

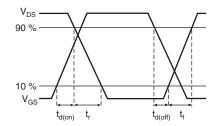


Fig. 10b - Switching Time Waveforms

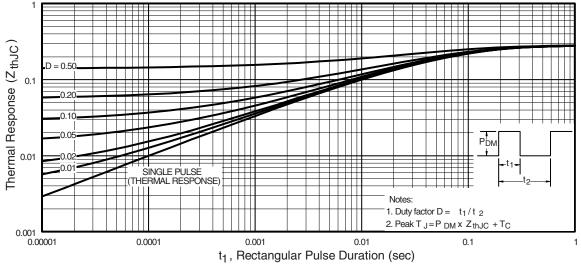


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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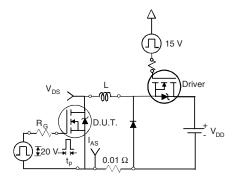


Fig. 12a - Unclamped Inductive Test Circuit

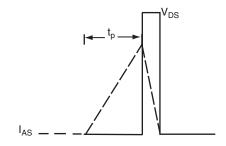


Fig. 12b - Unclamped Inductive Waveforms

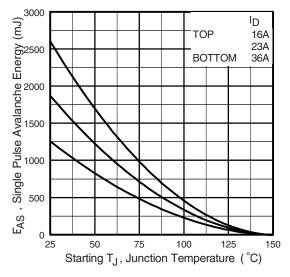


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

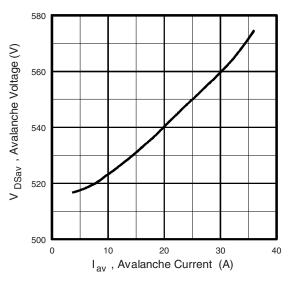


Fig. 12d - Maximum Avalanche Energy vs. Drain Current

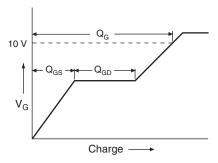


Fig. 13a - Basic Gate Charge Waveform

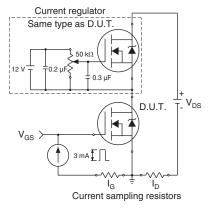
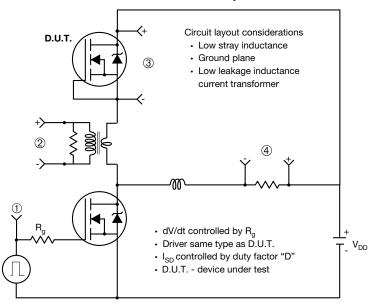


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



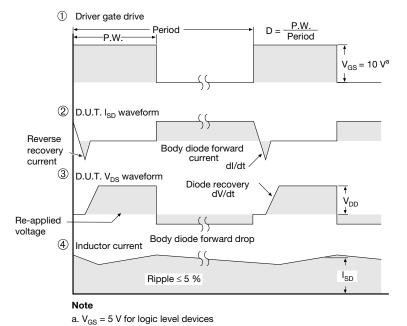


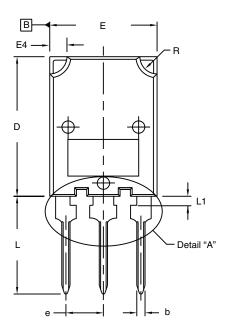
Fig. 14 - For N-Channel

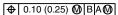
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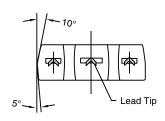


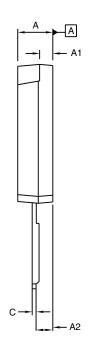


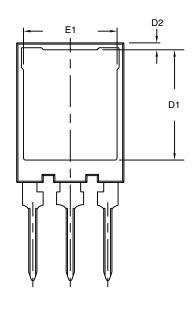
TO-274AA (HIGH VOLTAGE)

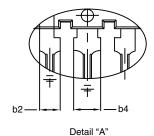












Scale: 2:1

	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.70	5.30	0.185	0.209	
A1	1.50	2.50	0.059	0.098	
A2	2.25	2.65	0.089	0.104	
b	1.30	1.60	0.051	0.063	
b2	1.80	2.20	0.071	0.087	
b4	3.00	3.25	0.118	0.128	
С	0.80	1.20	0.031	0.047	
D	19.80	20.80	0.780	0.819	

MAX.
WAA.
0.634
0.051
0.634
0.547
С
0.579
0.063
0.118

ECN: S-82247-Rev. A, 06-Oct-08

DWG: 5975

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outer extremes of the plastic body.
- 3. Outline conforms to JEDEC outline to TO-274AA.

Document Number: 91365 Revision: 06-Oct-08



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